

## PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT																
NATURE OF CONVEYANCE:	ASSIGNMENT																
CONVEYING PARTY DATA																	
<table border="1"><thead><tr><th>Name</th><th>Execution Date</th></tr></thead><tbody><tr><td>Kazutaka ANDO</td><td>03/16/2007</td></tr><tr><td>Tetsujiro KONDO</td><td>03/19/2007</td></tr><tr><td>Yasunobu NODE</td><td>03/19/2007</td></tr><tr><td>Michimasa OBANA</td><td>03/16/2007</td></tr><tr><td>Kei HIRAIZUMI</td><td>03/19/2007</td></tr><tr><td>Masanori MACHIMURA</td><td>03/16/2007</td></tr><tr><td>Masato AKAO</td><td>03/16/2007</td></tr></tbody></table>	Name	Execution Date	Kazutaka ANDO	03/16/2007	Tetsujiro KONDO	03/19/2007	Yasunobu NODE	03/19/2007	Michimasa OBANA	03/16/2007	Kei HIRAIZUMI	03/19/2007	Masanori MACHIMURA	03/16/2007	Masato AKAO	03/16/2007	
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RECEIVING PARTY DATA																	
Name:	Sony Corporation																
Street Address:	1-7-1 Konan, Minato-Ku																
City:	Tokyo																
State/Country:	JAPAN																
PROPERTY NUMBERS Total: 1																	
<table border="1"><thead><tr><th>Property Type</th><th>Number</th></tr></thead><tbody><tr><td>Application Number:</td><td>11675309</td></tr></tbody></table>	Property Type	Number	Application Number:	11675309													
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CORRESPONDENCE DATA																	
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NAME OF SUBMITTER:	Vivian Gillison																

OP \$40.00 11675309

PATENT

500249844

REEL: 019092 FRAME: 0232

Total Attachments: 3

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**PATENT**

**REEL: 019092 FRAME: 0233**

Docket Number: \_\_\_\_\_

## ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in IMAGE PROCESSING SYSTEM AND METHOD THEREFOR, IMAGE PROCESSING APPARATUS AND METHOD, IMAGE CAPTURING APPARATUS AND METHOD, PROGRAM RECORDING MEDIUM, AND PROGRAM for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 1-7-1 Konan, Minato-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, b hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 11/675,309, Filing Date: February 15, 2007.

This assignment executed on the dates indicated below.

Kazutaka ANDO

Name of first or sole inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of first or sole inventor

Kazutaka Ando

March 16, 2007

Signature of first or sole inventor

Date of this assignment

Tetsujiro KONDO

Name of second inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of second inventor

*Tetsujiro Kondo**March 19, 2007*

Signature of second inventor

Date of this assignment

Yasunobu NODE

Name of third inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of third inventor

*Yasunobu Node**March 19, 2007*

Signature of third inventor

Date of this assignment

Michimasa OBANA

Name of fourth inventor

Execution date of U.S. Patent Application

Tokyo, Japan

Residence of fourth inventor

*Michimasa Obana**March 16, 2007*

Signature of fourth inventor

Date of this assignment

Kei HIRAIZUMI

Name of fifth inventor

Execution date of U.S. Patent Application

Kanagawa, Japan

Residence of fifth inventor

*Kei Hiraizumi**March 19, 2007*

Signature of fifth inventor

Date of this assignment

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Masanori MACHIMURA

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Name of sixth inventor

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Execution date of U.S. Patent Application

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Tokyo, Japan

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Residence of sixth inventor

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*Masanori Machimura*

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*March 16, 2007*

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Signature of sixth inventor

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Date of this assignment

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Masato AKAO

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Name of seventh inventor

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Execution date of U.S. Patent Application

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Kanagawa, Japan

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Residence of seventh inventor

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*Masato Akao*

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*March 16, 2007*

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Signature of seventh inventor

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Date of this assignment

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Name of eighth inventor

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Execution date of U.S. Patent Application

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Residence of eighth inventor

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Signature of eighth inventor

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Date of this assignment

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Name of ninth inventor

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Execution date of U.S. Patent Application

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Residence of ninth inventor

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Signature of ninth inventor

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